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PATENTS ONLY

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To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies): **7/16/04**

1. Chih-Ming Wu      5. Shau-Lin Shue

2. Cheng-Tung Lin

3. Mei-Yun Wang

4. Chih-Wei Chang

Additional name(s) of conveying party(ies) attached?  Yes  No

2. Name and address of receiving party(ies)

Name: Taiwan Semiconductor Manufacturing Co., Ltd.

Internal Address: \_\_\_\_\_

\_\_\_\_\_

Street Address: No. 8, Li-Hsin Road 6

Science Based Industrial Park

City: Hsin-Chu State: \_\_\_\_\_ Zip: \_\_\_\_\_

Country: Taiwan 300-77 R.O.C.

Additional name(s) & address(es) attached?  Yes  No

3. Nature of conveyance:

Assignment       Merger

Security Agreement       Change of Name

Other \_\_\_\_\_

Execution Date: 07/05/2004

4. Application number(s) or patent number(s): **10892915**

If this document is being filed together with a new application, the execution date of the application is: 7/05/2004

A. Patent Application No.(s) \_\_\_\_\_

B. Patent No.(s) \_\_\_\_\_

Additional numbers attached?  Yes  No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: William H. Murray, Esquire

Internal Address: Duane Morris LLP

\_\_\_\_\_

Street Address: One Liberty Place

\_\_\_\_\_

City: Philadelphia State: PA Zip: 19103

6. Total number of applications and patents involved: **1**

7. Total fee (37 CFR 3.41).....\$ 40.00

Enclosed

Authorized to be charged to deposit account

8. Deposit account number: \_\_\_\_\_

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9. Signature.

Joseph A. Powers  
Name of Person Signing

Joseph A. Powers  
Signature

07/15/04  
Date

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Mail documents to be recorded with required cover sheet information to:

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**EXPRESS MAIL LABEL NO. EV 394065805 US ATTORNEY DOCKET NO. 2003.1510.1511/1085.283**

### **ASSIGNMENT AND AGREEMENT**

For value received, we, **Chii-Ming Wu, Cheng-Tung Lin, Mei-Yun Wang, Chih-Wei Chang, and Shau-Lin Shue** hereby sell, assign and transfer to **Taiwan Semiconductor Manufacturing Co., Ltd.**, with its principal place of business located at No. 8, Li-Hsin Road 6, Science-Based Industrial Park, Hsin-Chu, Taiwan 300-77, Republic of China, and its successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to **SEMICONDUCTOR STRUCTURE INCLUDING SILICIDE REGIONS AND METHOD OF MAKING SAME** described in an application for Letters Patent of the United States and all the rights and privileges in said application and under any and all Letters Patent and any divisions, continuations, continuations-in-part, reexamination certificates, reissues, and extensions thereof that may be granted in the United States for said inventions; and we also concurrently hereby sell, assign and transfer to **Taiwan Semiconductor Manufacturing Co., Ltd.** the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions.

We authorize **Taiwan Semiconductor Manufacturing Co., Ltd.** to make application for such protection in its own name and maintain such protection in any and all countries foreign to the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from us, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

We hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of **Taiwan Semiconductor Manufacturing Co., Ltd.** to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

We request that any and all patents for said inventions be issued to **Taiwan Semiconductor Manufacturing Co., Ltd.** in the United States and in all countries foreign to the United States, or to such nominees as **Taiwan Semiconductor Manufacturing Co., Ltd.** may designate.

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We agree that, when requested, we shall, without charge to Taiwan Semiconductor Manufacturing Co., Ltd. but at its expense, sign all papers, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection.

Inventor No. 1

Dated: 7/5/2004

Chii-Ming Wu  
Chii-Ming Wu

Residence:

Fl. 4, No. 15, Alley 6, Lane 621, Bei-An Rd., Taipei, Taiwan, R.O.C.

Inventor No. 2

Dated: 7/5/2004

Cheng-Tung Lin  
Cheng-Tung Lin

Residence:

5F., No.6, Alley 39, Lane 152, Sec. 2, Jhongsing Rd., Jhudong Township, Hsinchu County 310, Taiwan, R.O.C.

Inventor No. 3

Dated: 7/5/2004

Mei-Yun Wang  
Mei-Yun Wang


Residence:

15F-2, No.46, Section 3, Chung-Hwa Rd., Hsin-Chu City, Taiwan, R.O.C.

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Inventor No. 4

Dated: 7/5/04

  
Chih-Wei Chang

Residence:

7F, No.1008, Sec. 4, Chung-Hsin Rd. Hsin-Chu, Taiwan 310, R.O.C.

Inventor No. 5

Dated: 7/5/04

  
Shau-Lin Shue

Residence:

5F, No. 25, Alley 6, Lane 485, Kwung-Fu Rd. I, Hsinchu, Taiwan, R.O.C.